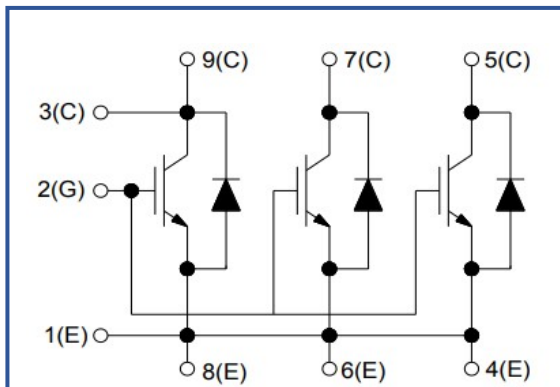


IGBT high-power module
3300 V 1500 A

Chip features

- IGBT chip
 - low $V_{CE(sat)}$ value
 - 10 μ s short circuit of 150°C
 - square RBSOA of 2xIC
 - low EMI
- FRD chip
 - fast and soft reverse recovery
 - low voltage drop

Design features

- AlSiC baseplate
- AlN DBC substrate

Typical application

- AC and DC motor drives
- high-power converters
- wind-powered generator inverters
- industrial equipment

Maximum rated values

Definition	Symbol	Conditions	Value	Unit
IGBT				
Collector-Emitter voltage	V_{CES}	$V_{GE} = 0$.	3300	V
Maximum allowable collector current (continuous)* ²	$I_{C 25}$	$T_{vj(max)} = 175^{\circ}C; T_c = 25^{\circ}C$.	3029	A
	$I_{C 95}$	$T_{vj(max)} = 175^{\circ}C; T_c = 95^{\circ}C$.	1500	A
Repetitive peak collector current* ¹	I_{CRM}	$I_{CRM} = 2 \times I_{C nom}; t_p = 1 ms$.	3000	A
Short-circuit duration	t_{psc}	$T_{vj} = 25^{\circ}C; V_{GE} = \pm 15 V; V_{CE} = 2500 V;$ $I_{C max} < 5800 A$.	10	μ s
		$T_{vj} = 150^{\circ}C; V_{GE} = \pm 15 V; V_{CE} = 2500 V;$ $I_{C max} < 5800 A$.	10	
Gate-Emitter voltage	V_{GES}		± 20	V
Junction operating temperature	$T_{vj(op)}$		-40...+150	°C
Inverse diode \ Freewheeling diode				
Repetitive peak reverse voltage	V_{RRM}	$V_{GE} = 0 V$.	3300	V
Maximum allowable forward current (continuous)* ²	$I_{F 25}$	$T_{vj(max)} = 175^{\circ}C; T_c = 25^{\circ}C$.	2472	A
	$I_{F 95}$	$T_{vj(max)} = 175^{\circ}C; T_c = 95^{\circ}C$.	1500	A
Repetitive peak forward current* ¹	I_{FRM}	$I_{FRM} = 2 \times I_{F nom}; t_p = 1 ms$.	3000	A
Junction operating temperature	$T_{vj(op)}$		-40...+150	°C
Module				
Storage temperature	T_{stg}		-40...+60	°C
Isolation voltage	V_{isol}	AC sin 50 Hz; t = 1 min.	6000	V

*1 Pulse width and repetition rate should be such that device junction temperature does not exceed maximum T_{vj} rating.

*2 $I_{C 25}, I_{F 25}$ & $I_{F 95}$ values were calculated in accordance with typical $U_{CE0}, r_{CE0}, U_{(T0)}$ and r_T .

Characteristics

Definition	Symbol	Conditions	Value			Unit.		
			min.	typ.	max.			
IGBT								
Collector-Emitter saturation voltage	V_{CEsat}	$V_{GE} = +15\text{ V}; I_C = 1500\text{ A}; t_u = 10\ \mu\text{s}.$	$T_{vj} = 25^\circ\text{C}$ $T_{vj} = 150^\circ\text{C}$	- 2.40	2.90 3.60	V V		
Gate-Emitter threshold voltage	$V_{GE(th)}$	$I_C = 120\text{ mA}; U_{CE} = U_{GE}; T_{vj} = 25^\circ\text{C}; t_u = 2\text{ ms}.$		5.50	6.10 7.00	V		
Collector-Emitter cut-off current	I_{CES}	$V_{CE} = 3300\text{ V}; t_u = 10\text{ ms}; V_{GE} = 0.$	$T_{vj} = 25^\circ\text{C}$ $T_{vj} = 150^\circ\text{C}$	- -	1.00 150.00	mA		
Gate-Emitter leakage current	I_{GES}	$V_{CE} = 0; V_{GE} = \pm 20\text{ V}; T_{vj} = 25^\circ\text{C}; t_u = \text{const}.$		-	1.00	μA		
Input capacitance	C_{ies}	$V_{CE} = 25\text{ V}; V_{GE} = 0\text{ V}; f = 1\text{ MHz}; T_{vj} = 25^\circ\text{C}.$		-	260	nF		
Output capacitance	C_{oes}			-	-	-	nF	
Reverse transfer capacitance	C_{res}			-	6	-	nF	
Total gate charge	Q_G		$V_{GE} = -15 \div 15\text{ V}.$		-	25	nC	
Internal gate resistance	R_{Gint}	$T_{vj} = 25^\circ\text{C}.$		-	110	$\mu\Omega$		
Turn-on delay time	$t_{d(on)}$	$V_{CE} = 1800\text{ V}; V_{GE} = \pm 15\text{ V}; I_{C\ max} = 1500\text{ A}; R_{G\ on} = 1\ \Omega; L_s = 150\text{ nH}.$	$T_{vj} = 25^\circ\text{C}$ $T_{vj} = 150^\circ\text{C}$	- -	750 730	- -	ns	
Rise time	t_{ri}		$T_{vj} = 25^\circ\text{C}$ $T_{vj} = 150^\circ\text{C}$	- -	340 360	- -	ns	
Turn-on energy	E_{on}		$T_{vj} = 25^\circ\text{C}$ $T_{vj} = 150^\circ\text{C}$	- -	1450 2100	- -	mJ	
Turn-off delay time	$t_{d(off)}$		$T_{vj} = 25^\circ\text{C}$ $T_{vj} = 150^\circ\text{C}$	- -	2100 2290	- -	ns	
Fall time	t_{fi}		$T_{vj} = 25^\circ\text{C}$ $T_{vj} = 150^\circ\text{C}$	- -	540 580	- -	ns	
Turn-off energy	E_{off}		$T_{vj} = 25^\circ\text{C}$ $T_{vj} = 150^\circ\text{C}$	- -	2400 3200	- -	mJ	
Collector-emitter threshold voltage	V_{CE0}		$V_{GE} = +15\text{ V}; T_{vj} = 150^\circ\text{C};$		-	1.07	-	V
On-State slope resistance (IGBT)	r_{CE0}		$I_{CE1} = 375\text{ A}; I_{CE2} = 1500\text{ A}; t_u = 10\ \mu\text{s}.$		-	1.35	-	$\text{m}\Omega$
Thermal resistance junction to case	$R_{th(j-c)}$		DC; $V_{GE} = +15\text{ V}.$		-	-	0.008	K/W
Inverse diode \ Freewheeling diode								
Forward voltage drop	V_F	$I_F = 1500\text{ A}; V_{GE} = 0; t_u = 10\ \mu\text{s}.$	$T_{vj} = 25^\circ\text{C}$ $T_{vj} = 150^\circ\text{C}$	- -	2.10 2.25	2.60 2.70	V V	
Reverse recovery time	t_{rr}	$V_{GE} = \pm 15\text{ V}; V_{CE} = 1800\text{ V}; I_{C\ max} = 1500\text{ A}; R_{G\ on} = 1\ \Omega; L_s = 150\text{ nH}.$	$T_{vj} = 25^\circ\text{C}$ $T_{vj} = 150^\circ\text{C}$	- -	- -	- -	ns ns	
Peak reverse current	I_{RM}		$T_{vj} = 25^\circ\text{C}$ $T_{vj} = 150^\circ\text{C}$	- -	1250 1450	- -	A A	
Recovered charge	Q_r		$T_{vj} = 25^\circ\text{C}$ $T_{vj} = 150^\circ\text{C}$	- -	1150 1980	- -	μC μC	
Reverse recovery energy	E_{rec}		$T_{vj} = 25^\circ\text{C}$ $T_{vj} = 150^\circ\text{C}$	- -	1550 2720	- -	mJ mJ	
Threshold voltage	$V_{(T0)}$		$T_{vj} = 150^\circ\text{C}; V_{GE} = 0; I_{CE1} = 375\text{ A};$		-	0.91	-	V
Forward slope resistance	r_T		$I_{CE2} = 1500\text{ A}; t_u = 10\ \mu\text{s}$		-	0.91	-	$\text{m}\Omega$
Thermal resistance junction to case	$R_{th(jc-D)}$	DC; $U_{GE} = +15\text{ V}.$		-	-	0.016	K/W	

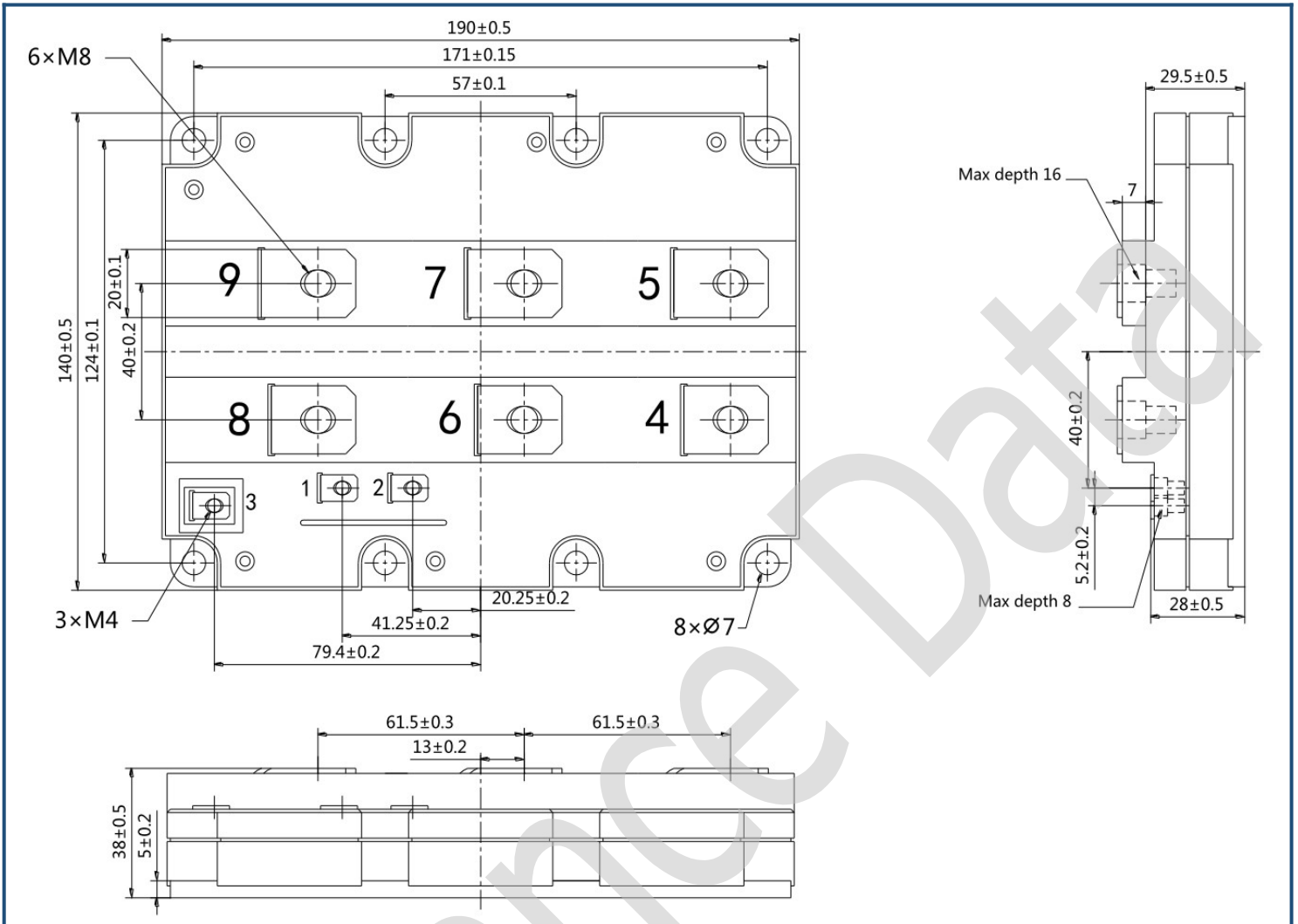
Module							
Pin resistance	R_{Pxy}	$T_{vj} = 25^{\circ}\text{C}$.	$R_{P5-7-9/4-6-8}$	-	-	-	m Ω
Parasitic inductance between terminals	L_{Pxy}		$L_{P5-7-9/4-6-8}$	-	10.00	-	nH
Thermal resistance case to heatsink	R_{thCH}	per module		-	-	6.00	K/kW
Mounting torque for screws to heatsink	M_s	to heatsink M6		-	-	5.00	N*m
Mounting torque for screws to control terminal	M_t	to terminals M4		-	-	2.00	N*m
Mounting torque for screws to power terminal	M_t	to terminals M8		-	-	10.00	N*m
Creepage distance	d_s			-	-	33.00	mm
Clearance	d_a			-	-	20.00	mm
Comparative Tracking Index	CTI			-	-	600	
Weight	W			-	-	1400	g

" - " Data will be refined as additional tests are conducted and statistics are collected.

Notes:

- Insulating material operating temperature 125°C max;
- Case temperature 125°C max;
- The recommended operating junction temperature $T_{vj\text{op}} = -40 \div +150^{\circ}\text{C}$.

Overall dimensions: Package type – HM



Part numbering guide

MIHM	-	SS	33	CA	-	1500	N	
MIHM								IGBT module package type: HM
		SS						Single switch
			33					Voltage rating ($V_{CES}/100$)
				CA				IGBT+FRD chipset modification
						1500		Current Rating
							N	Climatic version: normal climate

The information contained herein is protected by Copyright. In the interest of product improvement, Proton-Electrotex reserves the right to change datasheet without notice.